# SPN4392W N-Channel Enhancement Mode MOSFET

#### **DESCRIPTION**

The SPN4392W is the N-Channel logic enhancement mode power field effect transistors are produced using high cell density, DMOS trench technology.

This high density process is especially tailored to minimize on-state resistance.

These devices are particularly suited for low voltage application, notebook computer power management and other battery powered circuits where high-side switching.

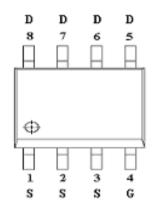
#### **FEATURES**

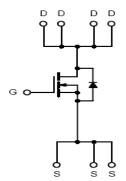
- 30V/13A,RDS(ON)=  $8m\Omega@VGS=10V$
- 30V/10A,RDS(ON)=  $12m\Omega$ @VGS=4.5V
- ◆ Super high density cell design for extremely low RDS (ON)
- ◆ Exceptional on-resistance and maximum DC current capability
- ♦ SOP 8P package design

#### **APPLICATIONS**

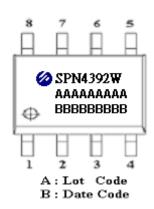
- Power Management in Note book
- Portable Equipment
- Battery Powered System
- High-Side DC/DC Converter
- Load Switch
- DSC
- LCD Display inverter

#### PIN CONFIGURATION(SOP – 8P)





#### **PART MARKING**



2011/06/03 **Ver.1** 

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# PIN DESCRIPTION

Pin	Symbol	Description	
1	S	Source	
2	S	Source	
3	S	Source	
4	G	Gate	
5	D	Drain	
6	D	Drain	
7	D	Drain	
8	D	Drain	

# **ORDERING INFORMATION**

Part Number	Package	Part Marking		
SPN4392WS8RGB	SOP- 8P	SPN4392W		

<sup>※</sup> SPN4392WS8RGB: 13" Tape Reel; Pb − Free; Halogen - Free

#### ABSOULTE MAXIMUM RATINGS

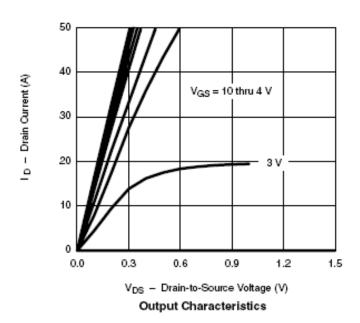
(Ta=25°C Unless otherwise noted)

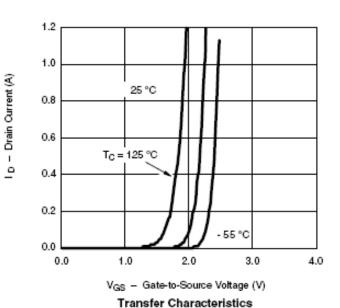
Parameter	Symbol	Typical	Unit	
Drain-Source Voltage	Vdss	30	V	
Gate –Source Voltage	VGSS	±20	V	
Continuous Drain Current(Tr-150°C)	TA=25°C	In	13	А
Continuous Drain Current(TJ=150°C)	TA=70°C	- Id	10	A
Pulsed Drain Current	Ідм	50	А	
Continuous Source Current(Diode Conduction)		Is	5.6	А
Decree Dissipation	TA=25°C	D-	2.5	<b>W</b> 7
Power Dissipation	TA=70°C	PD	1.6	W
Operating Junction Temperature		Тл	-55/150	$^{\circ}$
Storage Temperature Range		Tstg	-55/150	$^{\circ}\!\mathbb{C}$
Thermal Resistance-Junction to Ambient		RθJA	80	°C/W

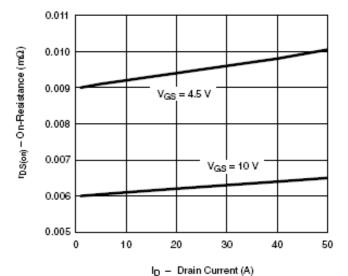
# **ELECTRICAL CHARACTERISTICS**

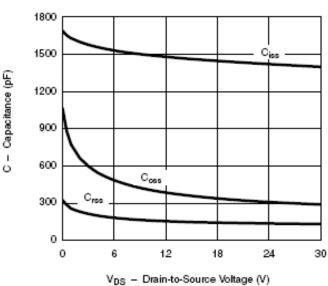
(TA=25°C Unless otherwise noted)

Parameter	Symbol	Conditions	Min.	Тур	Max.	Unit	
Static							
Drain-Source Breakdown Voltage	V(BR)DSS	$V_{GS} = 0V$ , $I_D = 250uA$	30			V	
Gate Threshold Voltage	VGS(th)	$V_{DS} = V_{GS}, I_{DS} = 250uA$	1.0		2.0	V	
Gate Leakage Current	Igss	$V_{DS} = 0V, V_{GS} = \pm 20 \text{ V}$			±100	nA	
		$V_{DS} = 30V, V_{GS} = 0V$			1		
Zero Gate Voltage Drain Current	Idss	$V_{DS} = 30V, V_{GS} = 0V,$ $T_{J} = 125C$			100	00 uA	
Drain-Source On-Resistance	RDS(on)	V <sub>GS</sub> = 10V, ID = 13A V <sub>GS</sub> = 4.5V, ID = 10A		0.006	0.008 0.012	Ω	
Forward Transconductance	gfs	$V_{DS} = 15V$ , $I_{D} = 20 A$	10			S	
Diode Forward Voltage	Vsd	$I_F = 13 \text{ A}, V_{GS} = 0V$		1.0	1.5	V	
Dynamic							
Total Gate Charge	Qg			12	20	nC	
Gate-Source Charge	Qgs	$V_{DS} = 15V, V_{GS} = 5V,$ $I_{D} = 13 \text{ A}$		4			
Gate-Drain Charge	Qgd	-ID -13 A		5		<b> </b>	
Input Capacitance	Ciss			1500		pF	
Output Capacitance	Coss	$V_{GS} = 0V$ , $V_{DS} = 25V$ , F=1MHz		320			
Reverse Transfer Capacitance	Crss	T-TIVITIZ		200		1	
Turn-On Time	td(on)			8	12		
Turn-On Time	tr	$(V_{DD} = 15 \text{ V}, I_D = 13 \text{ A},$		10	15		
T. OMT.	td(off)	$V_{GS}=10V,R_G=2.5\Omega)$		18	30	ns	
Turn-Off Time	tf			6	9		



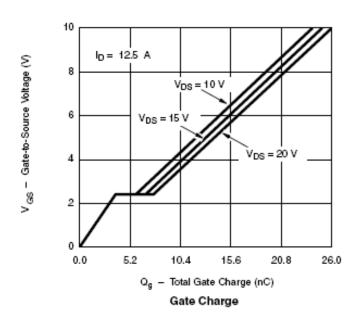


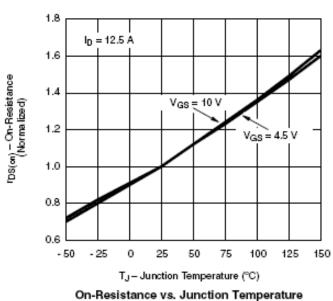


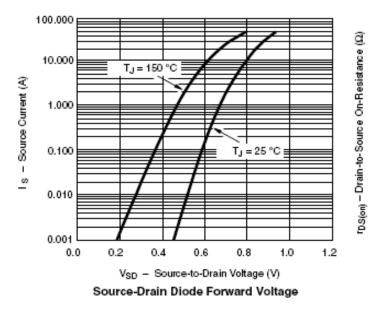


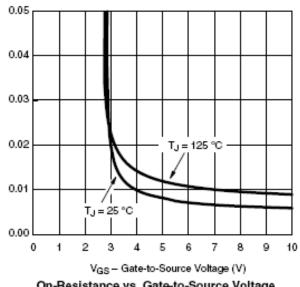
On-Resistance vs. Drain Current and Gate Voltage

V<sub>DS</sub> - Drain-to-Source Voltage (V) Capacitance

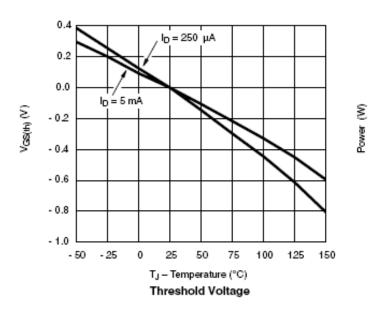


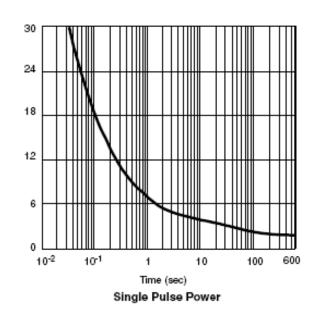


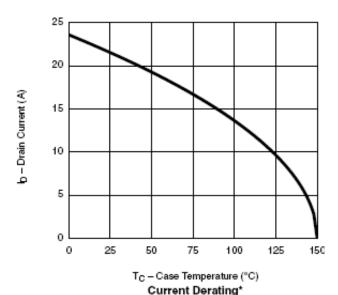


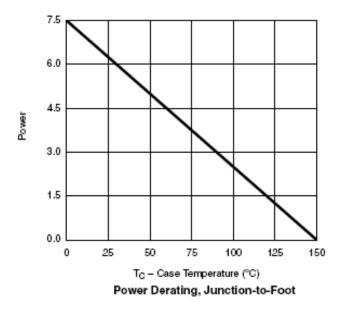


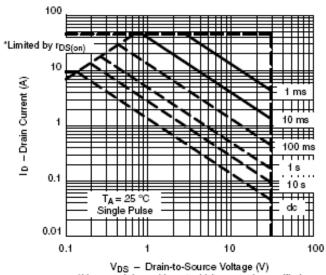
On-Resistance vs. Gate-to-Source Voltage







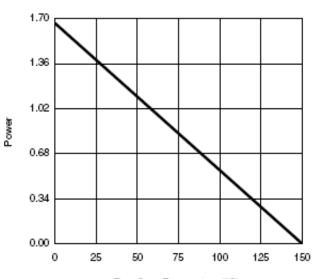




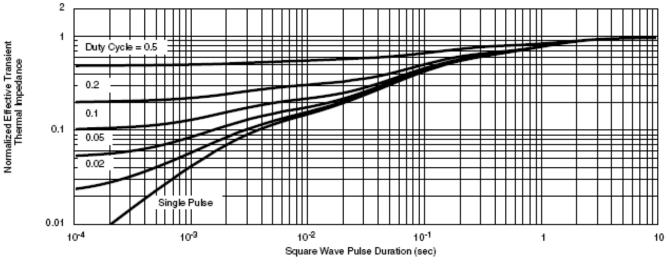
V<sub>DS</sub> - Drain-to-Source Voltage (V)

\*V<sub>GS</sub> > minimum V<sub>GS</sub> at which r<sub>DS(cn)</sub> is specified

Safe Operating Area, Junction-to-Ambient



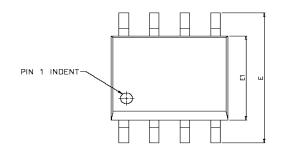
T<sub>C</sub> – Case Temperature (°C)
Power, Junction-to-Ambient

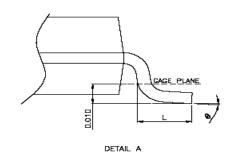


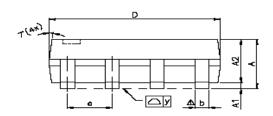
Normalized Thermal Transient Impedance, Junction-to-Foot

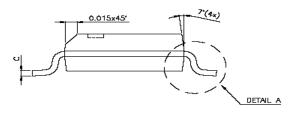


# **SOP- 8 PACKAGE OUTLINE**









0,4,100,10	DIMENSIONS IN MILLIMETERS		DIMENSIONS IN INCHES			
SYMBOLS	MIN	NOM	MAX	MIN	NOM	MAX
Α	1.47	1.60	1.73	0.058	0.063	0.068
A1	0.10		0.25	0.004		0.010
A2		1.45			0.057	
b	0.33	0.41	0.51	0.013	0.016	0.020
С	0.19	0.20	0.25	0.0075	0.008	0.0098
D	4.80	4.85	4.95	0.189	0.191	0.195
Е	5.80	6.00	6.20	0.228	0.236	0.244
E1	3.80	3.90	4.00	0.150	0.154	0.157
е		1.27			0.050	
L	0.38	0.71	1.27	0.015	0.028	0.050
<u></u> ∕2 y			0.076			0.003
0	0,		8*	0,		8*

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